Che-Kai Liu

Curriculum Vitae last update: 07/15/2024

TSMC North America and Technology Inc.

San Jose, CA 95134, USA

⊠ clius@tsmc.com

GGoogle Scholar in Linkedin My webpage

General Research Interests

My research interests lie in building scalable (beyond-) silicon (planar to FinFET) system-on-chips tailored for next-generation AI workloads. Specifically, I have the experience of designing and integrating custom/RTL blocks in TSMC 40ULP and 65GP nodes with industrial standard tapeout flow, from design to top-level integration.

Education

Aug.'23- **PhD Student, Electrical & Computer Engineering**, *Georgia Institute of Technology*, Atlanta, present GA, USA.

Advisor: Steve W. Chaddick school chair and Prof., Arijit Raychowdhury

Aug'19- Bachelor of Engineering, Electrical & Computer Engineering, Zhejiang University, Hangzhou,

July'23 Zhejiang, PRC.

Employment Record

June'24- Design Research Intern, Corporate Research TSMC, San Jose, CA, USA.

present Research focus: Design proof-of-concept large-scale SoC tapeouts with the focus on comp. arch.

Division: Corporate Research Design Solution (CRDSN) Division.

Supervisor: Dr. Win-San (Vince) Khwa; Manager: Dr. Meng-Fan (Marvin) Chang.

Aug.'23- Graduate Research Assistant, Georgia Institute of Technology, Atlanta, GA, USA.

Present Research focus: Mixed-signal circuit and architecture tapeouts for next-gen Al applications.

Experience

2022 Undergraduate Research Assistant, University of Notre Dame, IN, USA.

Advisor: Leo E. and Patti Ruth Linbeck Professor of Engineering, X. Sharon Hu

2022 Undergraduate Research Assistant, University of California Irvine, CA, USA.

Advisor: Prof. Mohsen Imani

Publications *: Equal Contributions.

DATE 2024 Zishen Wan*, **Che-Kai Liu***, Mohamed Ibrahim, Hanchen Yang, Samuel Spetalnick, Tushar Krishna, and Arijit Raychowdhury. H3dfact: Heterogeneous 3d integrated cim for factorization with holographic perceptual representations. In *Design Automation and Test in Europe. Acceptance rate: 25%.* ACM/IEEE, DATE 2024.

ISPASS 2024 Zishen Wan, **Che-Kai Liu**, Hanchen Yang, Ritik Raj, Chaojian Li, Haoran You, Yonggan Fu, Cheng Wan, Yingyan (Celine) Lin, Tushar Krishna, and Arijit Raychowdhury. Towards cognitive ai systems: Workload and characterization of neuro-symbolic ai. In *IEEE International Symposium* on Performance Analysis of Systems and Software. Acceptance rate: 34%. IEEE, ISPASS 2024.

JATS 2024 Zhenkun Fan*, Zishen Wan*, **Che-Kai Liu**, Anni Lu, Kshitij Bhardwaj, and Arijit Raychowdhury. Benchmarking test-time dnn adaptation at edge with compute-in-memory. In *ACM Journal on Autonomous Transportation Systems*. ACM, JATS 2024.

- DATE 2024 Zhicheng Xu, **Che-Kai Liu**, Chao Li, Ruibin Mao, Jianyi Yang, Thomas Kämpfe, Mohsen Imani, Can Li, Cheng Zhuo, and Xunzhao Yin. Ferex: A reconfigurable design of multi-bit ferroelectric compute-in-memory for nearest neighbor search. In *Design Automation and Test in Europe. Acceptance rate: 25%.* ACM/IEEE, DATE 2024.
- ICCAD 2024 Chengyu Ni, Sijie Chen, **Che-Kai Liu**, Liu Liu, Mohsen Imani, Thomas Kämpfe, Kai Ni, Michael Niemier, Xiaobo Sharon Hu, Cheng Zhuo, and Xunzhao Yin. Tap-cam: A tunable approximate matching engine based on ferroelectric content addressable memory. In *43rd IEEE/ACM International Conference on Computer-Aided Design.*, ICCAD 2024.
- TCAS-I 2024 Hamza E. Barkam, Sanggeon Yun, Paul R. Genssler, **Che-Kai Liu**, Zhuowen Zou, Hussam Amrouch, and Mohsen Imani. In-memory acceleration of hyperdimensional genome matching on unreliable emerging technologies. In *IEEE Transactions on Circuits and Systems I: Regular Papers*. IEEE, TCAS-I 2024.
- ICCAD 2023 Shengxi Shou, **Che-Kai Liu**, Sanggeon Yun, Zishen Wan, Kai Ni, Mohsen Imani, X Sharon Hu, Jianyi Yang, Cheng Zhuo, and Xunzhao Yin. See-mcam: A scalable multi-bit fefet content addressable memory for energy efficient associative search. In *42nd IEEE/ACM International Conference on Computer-Aided Design. Acceptance rate: 23%*, ICCAD 2023.
- MLSys 2023 Zishen Wan, **Che-Kai Liu***, Hanchen Yang*, Chaojian Li*, Haoran You*, Yonggan Fu, Cheng Wan, Tushar Krishna, Yingyan Lin, and Arijit Raychowdhury. Towards cognitive ai system: A survey and prospective on neuro-symbolic ai. In *Workshop on Systems for Next-Gen AI Paradigms, Sixth Conference on Machine Learning and Systems*, MLSys 2023.
- DATE 2023 Hamza E. Barkam, Sanggeon Yun, Paul R. Genssler, Zhuowen Zou, **Che-Kai Liu**, Hussam Amrouch, and Mohsen Imani. Hdgim: Hyperdimensional genome sequence matching on unreliable highly-scaled fefet. In *Proceedings of the IEEE/ACM Design Automation and Test in Europe. Acceptance rate: 25%.* IEEE/ACM, DATE 2023.
- ICCAD 2022 **Che-Kai Liu**, Haobang Chen, Mohsen Imani, Kai Ni, Arman Kazemi, Ann Franchesca Laguna, Michael Niemier, Xiaobo Sharon Hu, Liang Zhao, Cheng Zhuo, and Xunzhao Yin. Cosime: Fefet based associative memory for in-memory cosine similarity search. In 41st IEEE/ACM International Conference on Computer-Aided Design. Acceptance rate: 22%, ICCAD 2022.

Talks

- 2024 Mar. H3DFact: Heterogeneous 3D Integrated CIM for Factorization with Holographic Perceptual Representations, 2024 IEEE Design Automation and Test in Europe (DATE), Valencia, Spain.
- 2024 Mar. Heterogeneous 3D Integrated CIM for Factorization, 2024 Center for the Co-Design of Cognitive Systems (CoCoSys), Annual Review, Atlanta, USA
- 2023 Oct. SEE-MCAM: A Scalable Multi-bit FeFET Content Addressable Memory for Energy Efficient Associative Search, IEEE/ACM 42nd International Conference on Computer-Aided Design (ICCAD), San Francisco, CA, USA.
- 2023 May "When Vector Symbolic Architecture meets Compute-in-Memory", ICSR Lab, Georgia Institute of Technology, Virtual
- 2022 Oct. Student Research Competition, IEEE/ACM 41st International Conference on Computer-Aided Design (ICCAD), San Diego, CA, USA.
- 2022 Nov. Cosime: Fefet based associative memory for in-memory cosine similarity search, IEEE/ACM 41^{st} International Conference on Computer-Aided Design (ICCAD), 2023, San Diego, CA, USA.
- 2022 Oct. "Compute-in-Memory: A Cross-Layer Perspective", Bias Lab, University of California, Irvine, CA, USA.
- 2022 Sep. "An efficient Associative Memory Engine for Cosine Similarity-Based Nearest Neighbor Search", ACM/IEEE Embedded System Week (ESWEEK), Edge Intelligent Computing workshop, virtual.

Skills

Technical (System) Verilog, C, Synopsys PrimeTime/VCS/DC/ICC/StarRC, Cadence Virtu-Skill oso/Calibre/Innovus/PVS/AMS, Python, MATLAB, KiCAD, Intel Quartus, TCL, Makefile.

Reviewer for

- 2024 2024 IEEE/ACM International Conference on Computer-Aided Design (ICCAD).
- 2023 2024 IEEE International Symposium on Circuits and Systems (ISCAS).
- 2022-2023 IEEE J. on Emerging and Selected Topics in Circuits & Systems (JETCAS).
- 2023-2024 ACM Journal on Autonomous Transportation Systems (JATS).

Courses Participated during Ph.D. @ GaTech ECE

- Spring, 2024: **ECE8824: Silicon Validation (Chip Testing)**, *Instructor: Prof. Visvesh S. Sathe.*
- Spring, 2024: ECE6412: Analog Integrated Circuit Design, Instructor: Prof. Gabriel A. Rincon-Mora.
 - Fall, 2023: ECE8903: Special Problems, Instructor: Prof. Arijit Raychowdhury.
 - Fall, 2023: ECE6130: Advanced VLSI Systems, Instructor: Prof. Arijit Raychowdhury.
 - Fall, 2023: CS6290/ECE6100: Advanced Computer Architecture, Instructor: Prof. Cong (Callie) Hao.
 - Fall, 2023: ECE4804: VLSI Theory to Tape-out, Instructor: Prof. Visvesh S. Sathe.

References

Dr. Arijit Raychowdhury

Fellow of IEEE

Steve W. Chaddick School Chair and Professor, School of Electrical & Computer Engineering Georgia Institute of Technology, Atlanta, GA, USA

ightharpoonup arijit.raychowdhury@ece.gatech.edu

Dr. Win-San (Vince) Khwa

Technical Manager. Corporate Research, TSMC, Taiwan, ROC